

PH311

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LIGHT-TO-VOLTAGE CONVERTERS



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LIGHT-TO-VOLTAGE CONVERTERS

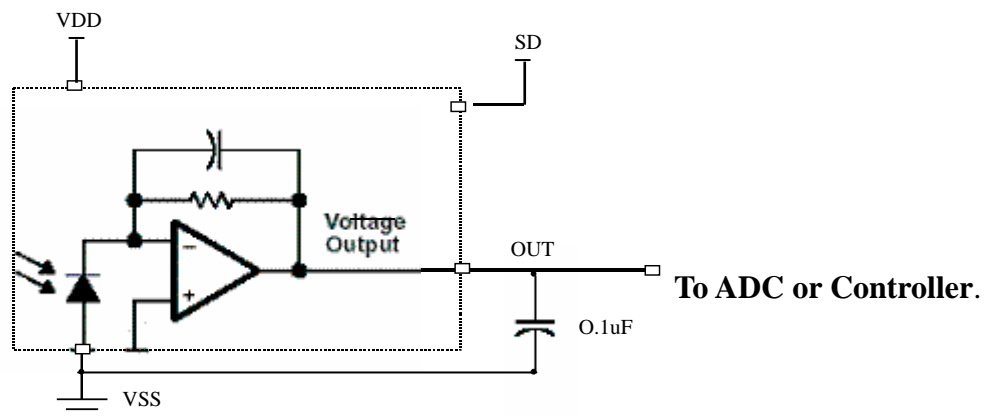
GENERAL DESCRIPTION

PH311 is a low-noise, high-sensitivity and light-to-voltage converter . The device integrates a photodiode and a trans-impedance amplifier in a single IC and is characterized by its peak wavelength at 800 nm.

FEATURES

1. Integrating photodiode, operational amplifier, and feedback components.
2. Tiny SMD type package:
 - Width: 2 mm
 - Height: 1.3 mm
 - Depth: 0.5mm
3. High sensing illuminance responsivity (0~550lx).
4. Rail-to-Rail Output
5. Wide power supply range(2.7~5.5V) .
6. Reject 50Hz /60Hz light ripple Noise
7. High power-supply rejection
8. Shut-Down function
9. Excellent output linearity of illuminance.

FUNCTIONAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

ITEM	SYMBOL	RATING	UNIT
Supply Voltage	V_{DD}	-0.5~6	V
Output Current	I_o	± 10	mA
Operating Temperature	T_{opr}	-25 to +85	$^{\circ}C$
Storage Temperature	T_{stg}	-40 to +85	$^{\circ}C$
Electrostatic Damage	ESD	4	kV

RECOMMENDED OPERATING CONDITIONS

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V_{DD}	2.7	3.3 5.0	5.5	V

ELECTRICAL CHARACTERISTICS ($V_{DD}=5V$, $T_A=25^{\circ}C$, if not mentioned)

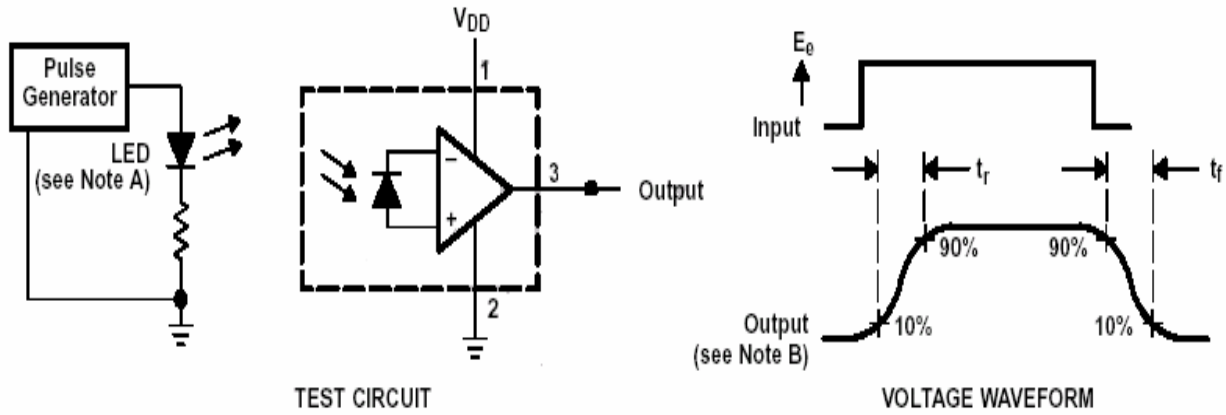
ITEM	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Output Dark Voltage	V_D	$E_e = 0 \text{ lx}$			25	mV
Max Output Voltage Swing	V_{OM}	$V_{DD} = 5V$	4.7	4.9	5.0	V
Output Voltage	V_O	$E_e = 100 \text{ lx}$ (Note 1)	0.645	0.86	1.075	V
Illuminance Responsivity	R_v	(Note 1)	6.45	8.6	10.75	mV/lx
Supply Current	$I_{DD(0 \text{ lx})}$	$V_{DD}=5V$, $E_e = 0 \text{ lx}$	52	65	78	μA

Note 1: Fluorescence light is used as light source. However, white LED is substituted in a mass-production process.

SWITCHING CHARACTERISTICS ($V_{DD} = 5 V$, $T_A = 25^{\circ}C$, unless otherwise noted)

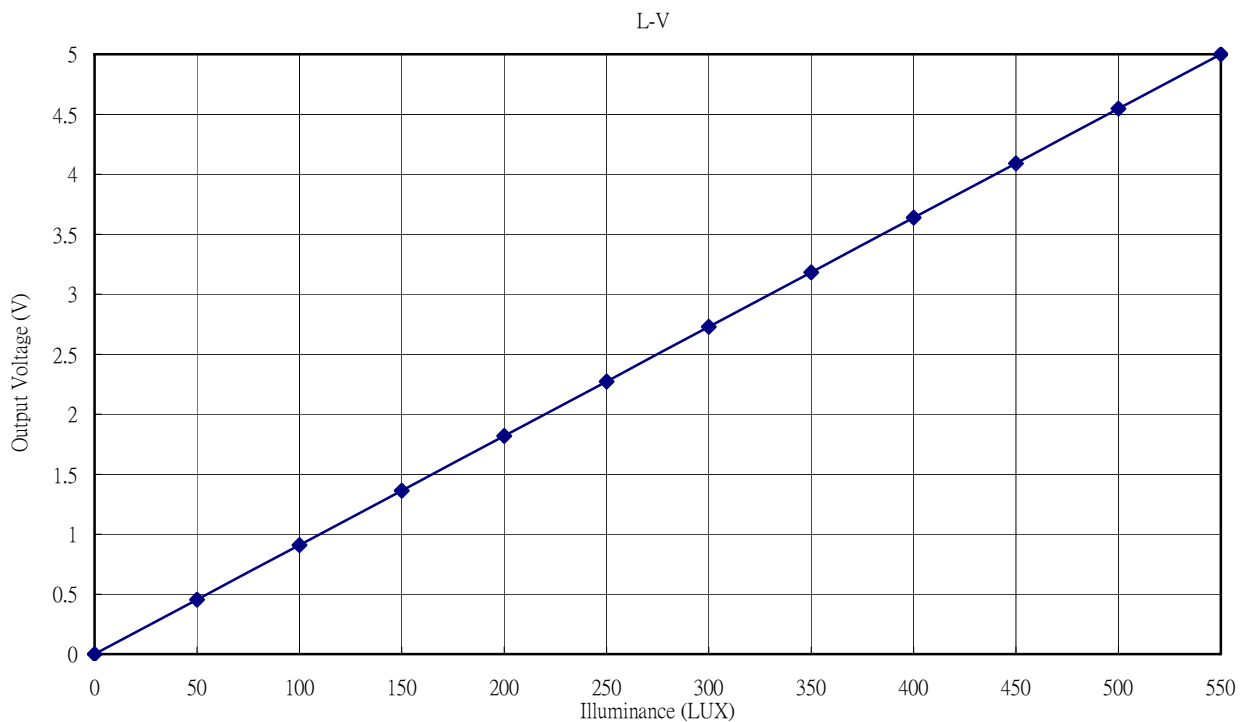
ITEM	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Output Pulse Rise Time (10% to 90% of Final Value)	t_r	$E_e = 0 \text{ lx}$ to 660 lx	30	60	100	ms
Output Pulse Fall Time (10% to 90% of Final Value)	t_f	$E_e = 660 \text{ lx}$ to 0 lx	30	60	100	ms

Parameter Measurement Information



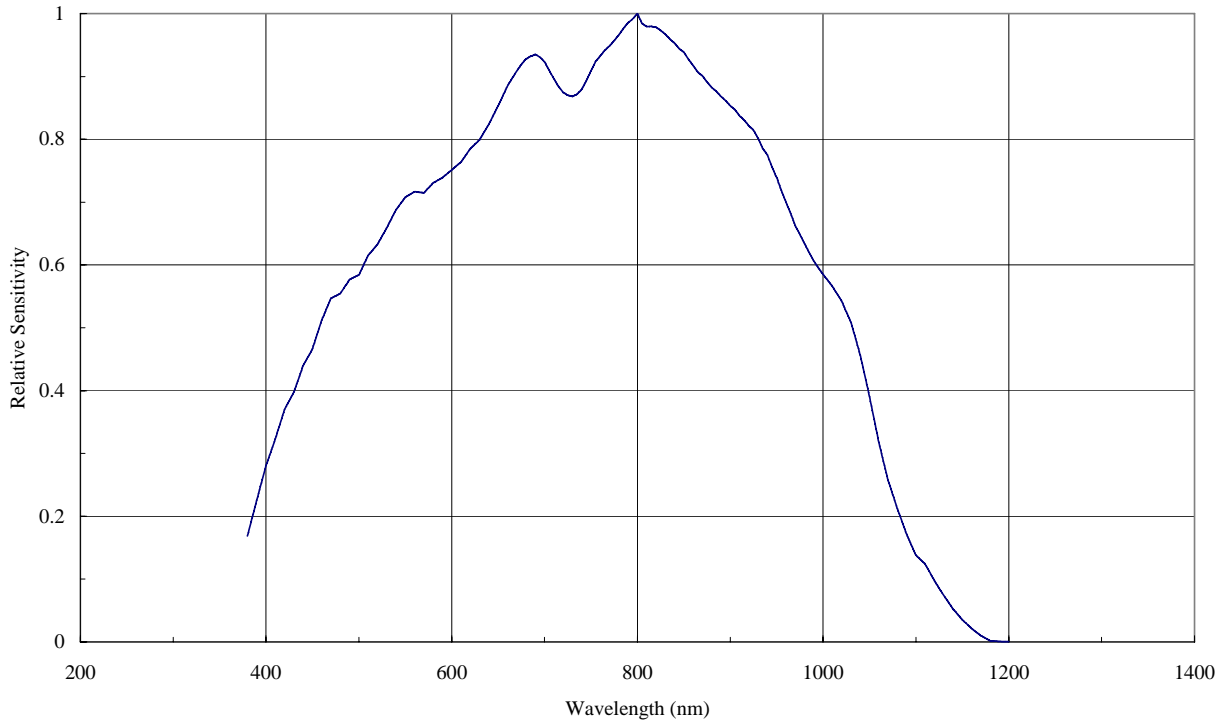
- NOTES: A. The input irradiance is supplied by a pulsed light-emitting diode with the following characteristics: $t_r < 1\mu s$, $t_f < 1\mu s$.
- B. The output waveform is monitored on an oscilloscope with the following characteristics: $t_r < 100ns$, $Z_i \geq 1M\ \Omega$, $C_L = 13pF$.

Output Voltage v.s. Illuminance E_v (lux)

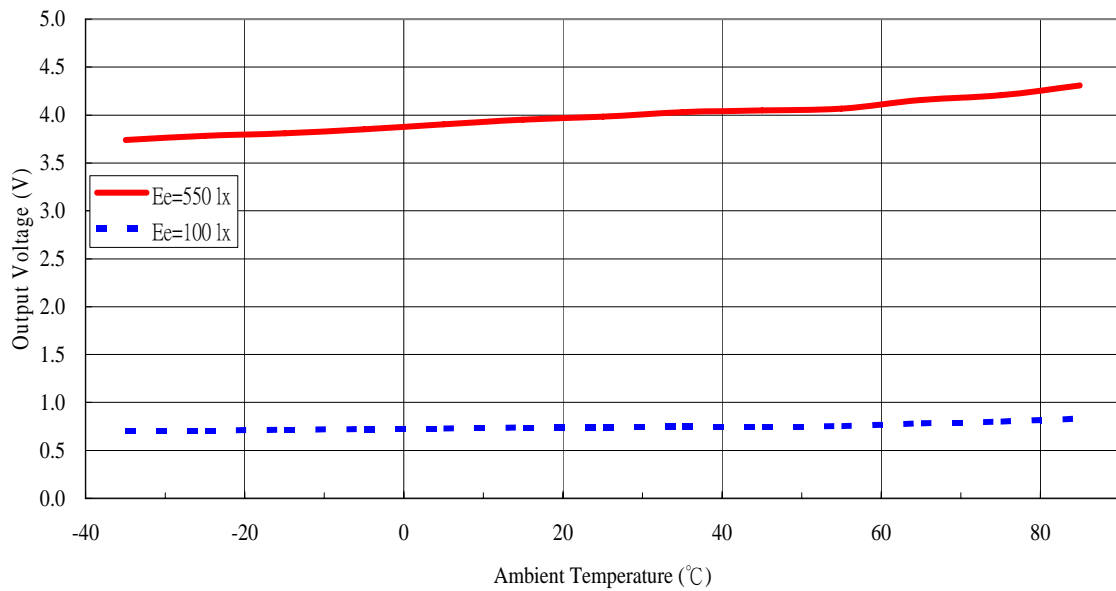




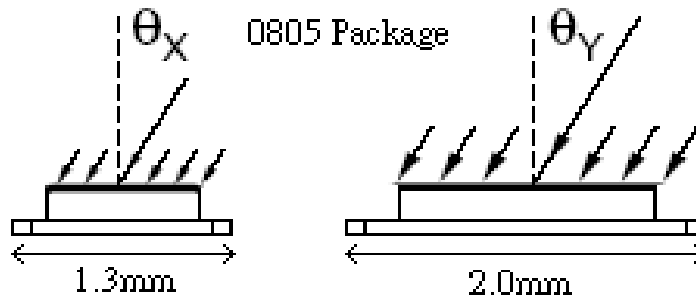
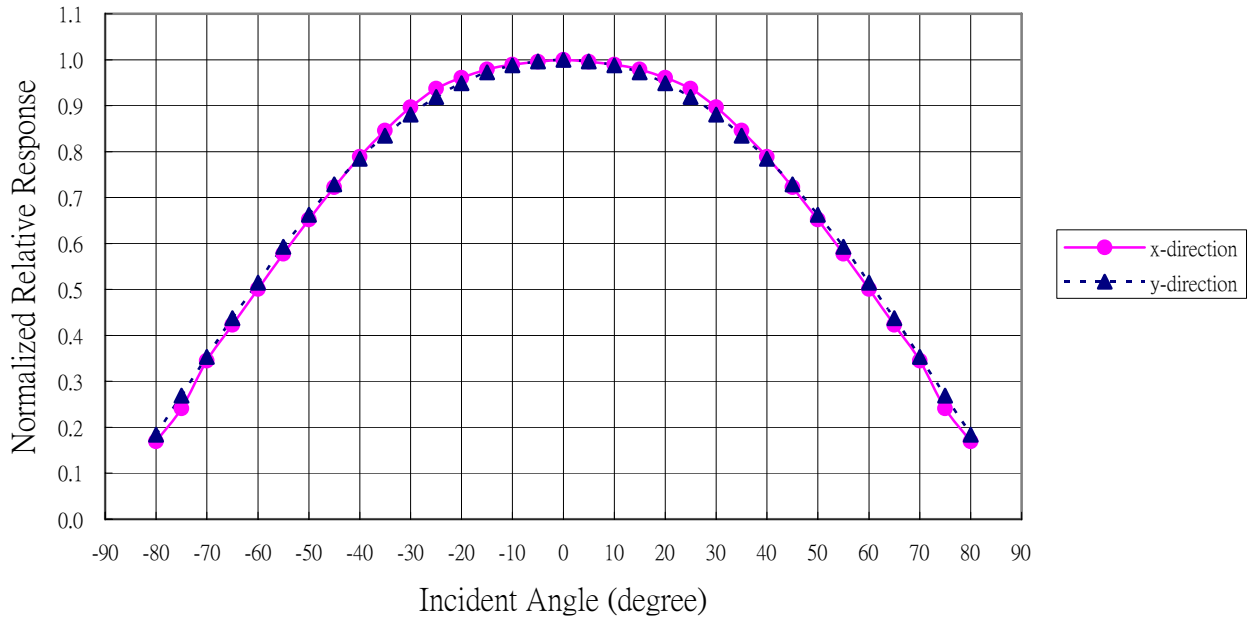
Spectral Response



Relative V-Ta



Relative Response v.s. Incident Angle



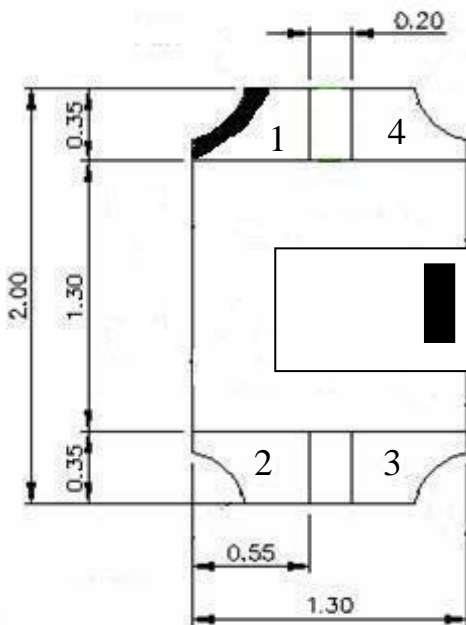


PAD DESCRIPTIONS

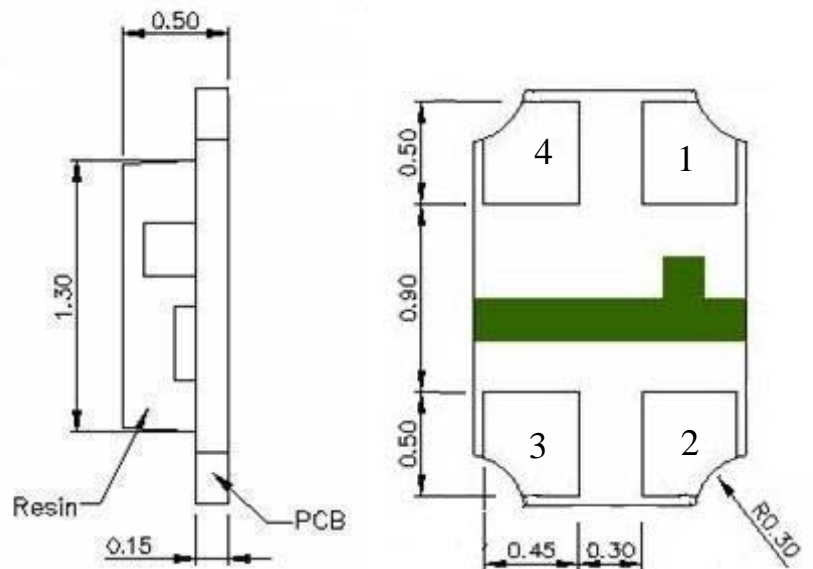
PAD NO.	PAD NAME	DESCRIPTIONS
1	VSS	Ground
2	OUT	Output
3	SD	Shut-down (High Active)
4	VDD	Power

PACKAGE DESCRIPTIONS

TOP VIEW

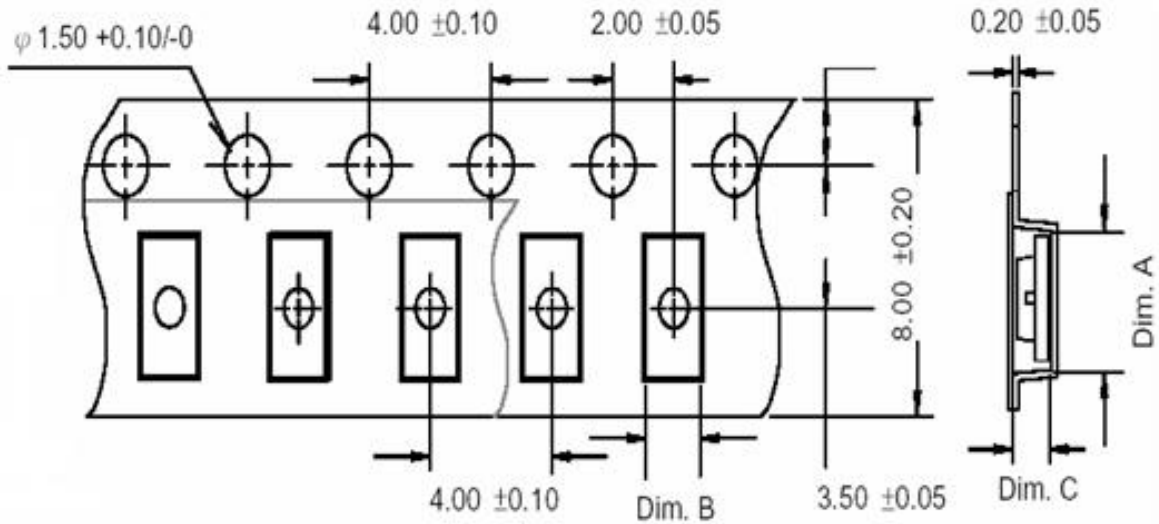


BOTTOM VIEW



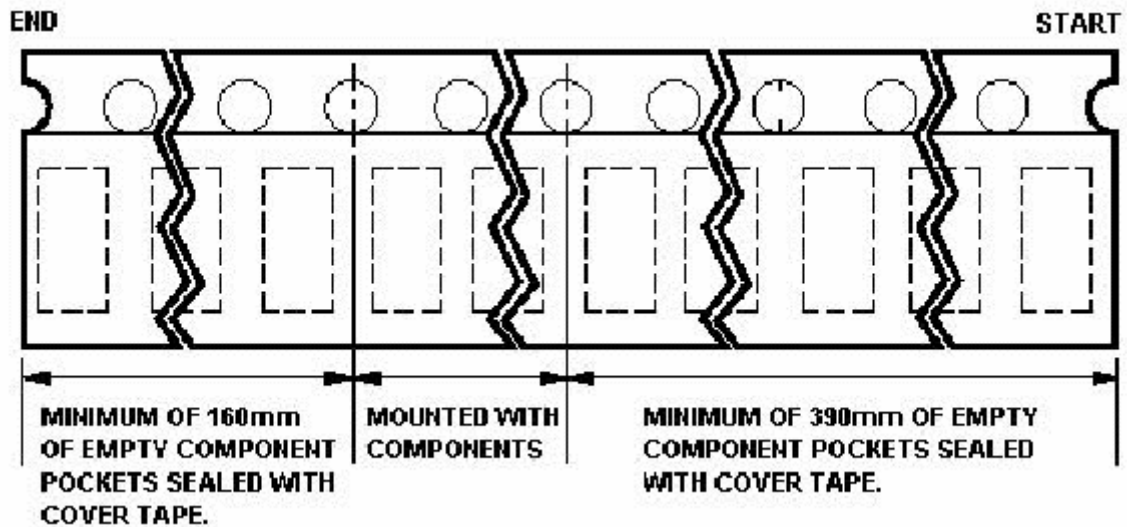


TAPE DIMENSION



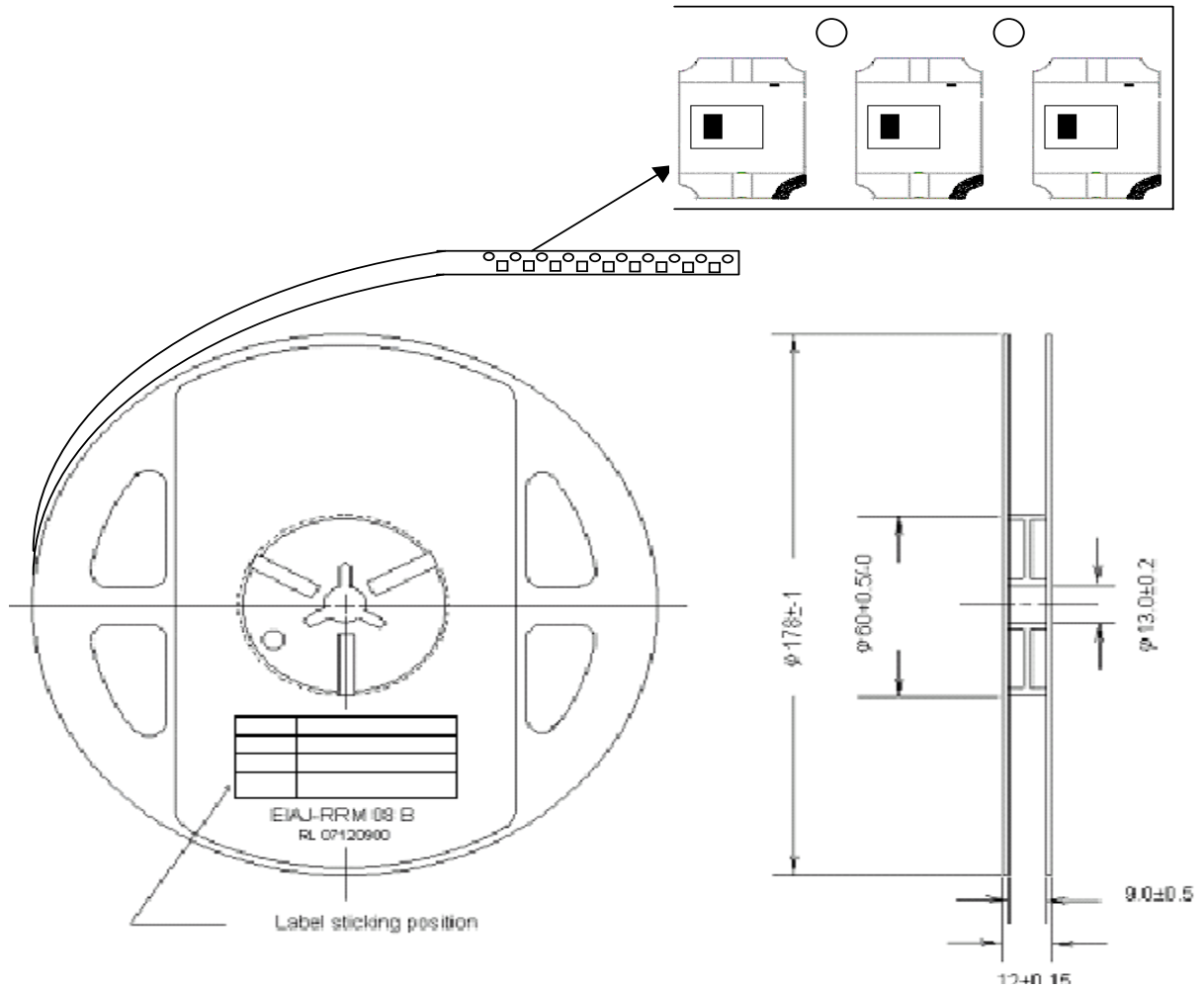
Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-372	2.24 ± 0.10	1.37 ± 0.10	0.74 ± 0.10	2K

Unit: mm





REEL DIMENSION



REFLOW SOLDERING

(1) Recommend soldering paste specification:

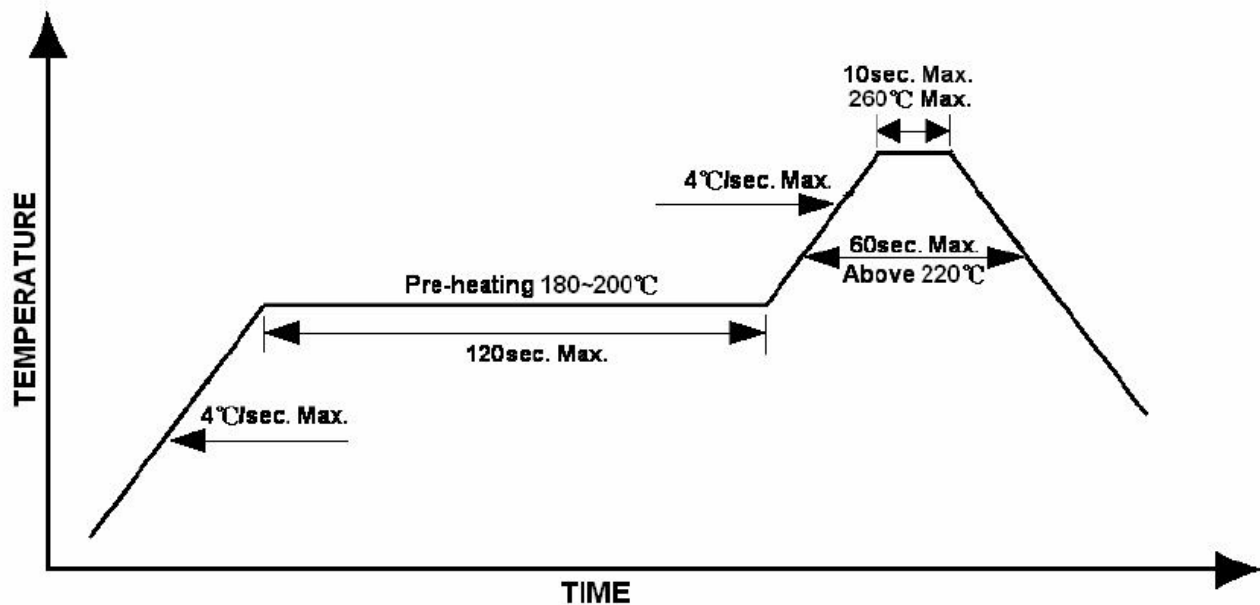
Operating temp.: Above 220°C , 60sec Max.

Peak temp.: 260°C, Max., 10sec Max.

(2) Never take next process until the component is cooled down to room temperature after reflow.

(3) The recommended reflow soldering profile is following:

Lead-free Solder



REWORK

- (1) Customer must finish rework within 3 sec. under 350°C .
- (2) The head of iron cannot touch copper foil.
- (3) Twin-head type is preferred.



The products listed herein are designed for ordinary electronic applications, such as electrical appliances, audio-visual equipment, communications devices and so on. Hence, it is advisable that the devices should not be used in medical instruments, surgical implants, aerospace machinery, nuclear power control systems, disaster/crime-prevention equipment and the like. Misusing those products may directly or indirectly endanger human life, or cause injury and property loss.

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